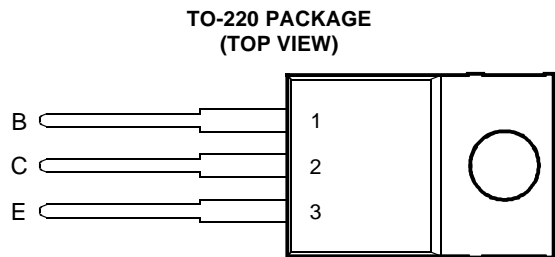


# BDW94, BDW94A, BDW94B, BDW94C PNP SILICON POWER DARLINGTONS

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SEPTEMBER 1993 - REVISED MARCH 1997

- Designed for Complementary Use with BDW93, BDW93A, BDW93B and BDW93C
- 80 W at 25°C Case Temperature
- 12 A Continuous Collector Current
- Minimum  $h_{FE}$  of 750 at 3 V, 5 A



Pin 2 is in electrical contact with the mounting base.

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## absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING		SYMBOL	VALUE	UNIT
Collector-base voltage ( $I_E = 0$ )	BDW94	$V_{CBO}$	-45	V
	BDW94A		-60	
	BDW94B		-80	
	BDW94C		-100	
Collector-emitter voltage ( $I_B = 0$ )	BDW94	$V_{CEO}$	-45	V
	BDW94A		-60	
	BDW94B		-80	
	BDW94C		-100	
Emitter-base voltage		$V_{EBO}$	-5	V
Continuous collector current		$I_C$	-12	A
Continuous base current		$I_B$	-0.3	A
Continuous device dissipation at (or below) 25°C case temperature (see Note 1)		$P_{tot}$	80	W
Continuous device dissipation at (or below) 25°C free air temperature (see Note 2)		$P_{tot}$	2	W
Operating junction temperature range		$T_j$	-65 to +150	°C
Storage temperature range		$T_{stg}$	-65 to +150	°C
Operating free-air temperature range		$T_A$	-65 to +150	°C

NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C.  
2. Derate linearly to 150°C free air temperature at the rate of 16 mW/°C.

## PRODUCT INFORMATION

Information is current as of publication date. Products conform to specifications in accordance with the terms of Power Innovations standard warranty. Production processing does not necessarily include testing of all parameters.



# BDW94, BDW94A, BDW94B, BDW94C

## PNP SILICON POWER DARLINGTONS

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### electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS				MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$ Collector-emitter breakdown voltage	$I_C = -100 \text{ mA}$	$I_B = 0$	(see Note 3)	BDW94 BDW94A BDW94B BDW94C	-45 -60 -80 -100			V
$I_{CEO}$ Collector-emitter cut-off current	$V_{CB} = -40 \text{ V}$ $V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -80 \text{ V}$	$I_B = 0$ $I_B = 0$ $I_B = 0$ $I_B = 0$		BDW94 BDW94A BDW94B BDW94C			-1 -1 -1 -1	mA
$I_{CBO}$ Collector cut-off current	$V_{CB} = -45 \text{ V}$ $V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$ $V_{CB} = -45 \text{ V}$ $V_{CB} = -60 \text{ V}$ $V_{CB} = -80 \text{ V}$ $V_{CB} = -100 \text{ V}$	$I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$ $I_E = 0$	$T_C = 150^\circ\text{C}$ $T_C = 150^\circ\text{C}$ $T_C = 150^\circ\text{C}$ $T_C = 150^\circ\text{C}$	BDW94 BDW94A BDW94B BDW94C BDW94 BDW94A BDW94B BDW94C			-0.1 -0.1 -0.1 -0.1 -5 -5 -5 -5	mA
$I_{EBO}$ Emitter cut-off current	$V_{EB} = -5 \text{ V}$	$I_C = 0$					-2	mA
$h_{FE}$ Forward current transfer ratio	$V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$ $V_{CE} = -3 \text{ V}$	$I_C = -3 \text{ A}$ $I_C = -10 \text{ A}$ $I_C = -5 \text{ A}$	(see Notes 3 and 4)		1000 100 750			
$V_{CE(sat)}$ Collector-emitter saturation voltage	$I_B = -20 \text{ mA}$ $I_B = -100 \text{ mA}$	$I_C = -5 \text{ A}$ $I_C = -10 \text{ A}$	(see Notes 3 and 4)				-2 -3	V
$V_{BE(sat)}$ Base-emitter saturation voltage	$I_B = -20 \text{ mA}$ $I_B = -100 \text{ mA}$	$I_C = -5 \text{ A}$ $I_C = -10 \text{ A}$	(see Notes 3 and 4)				-2.5 -4	V
$V_{EC}$ Parallel diode forward voltage	$I_E = -5 \text{ A}$ $I_E = -10 \text{ A}$	$I_B = 0$ $I_B = 0$					-2 -4	V

NOTES: 3. These parameters must be measured using pulse techniques,  $t_p = 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

### thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{\theta JC}$ Junction to case thermal resistance			1.56	$^\circ\text{C/W}$
$R_{\theta JA}$ Junction to free air thermal resistance			62.5	$^\circ\text{C/W}$

## TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN  
vs  
COLLECTOR CURRENT

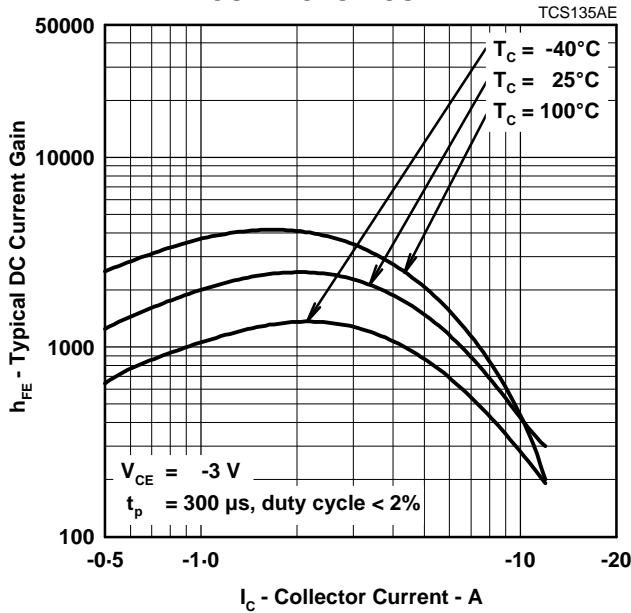


Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE  
vs  
COLLECTOR CURRENT

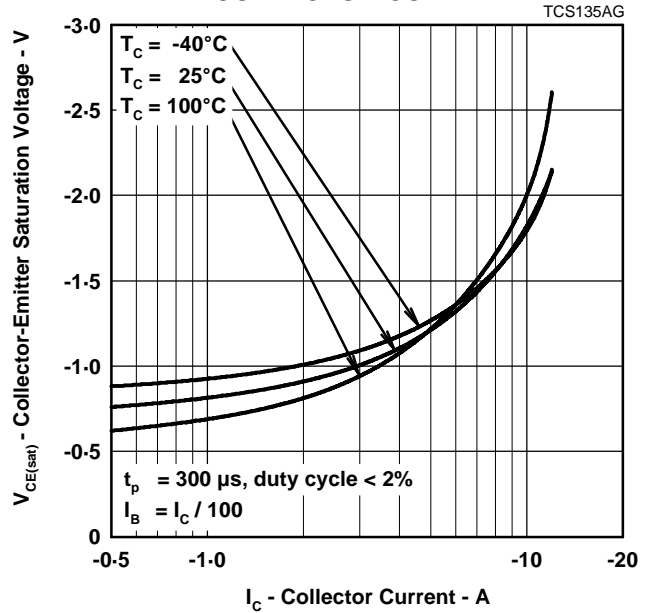


Figure 2.

BASE-EMITTER SATURATION VOLTAGE  
vs  
COLLECTOR CURRENT

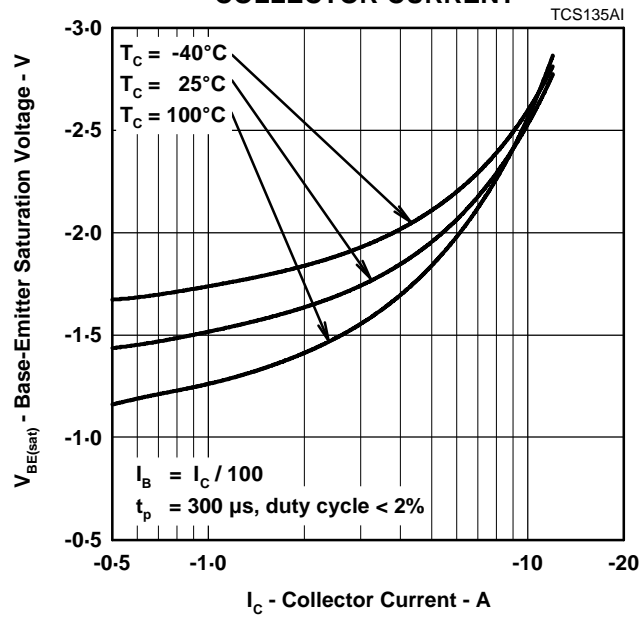


Figure 3.

BDW94, BDW94A, BDW94B, BDW94C  
PNP SILICON POWER DARLINGTONS

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THERMAL INFORMATION

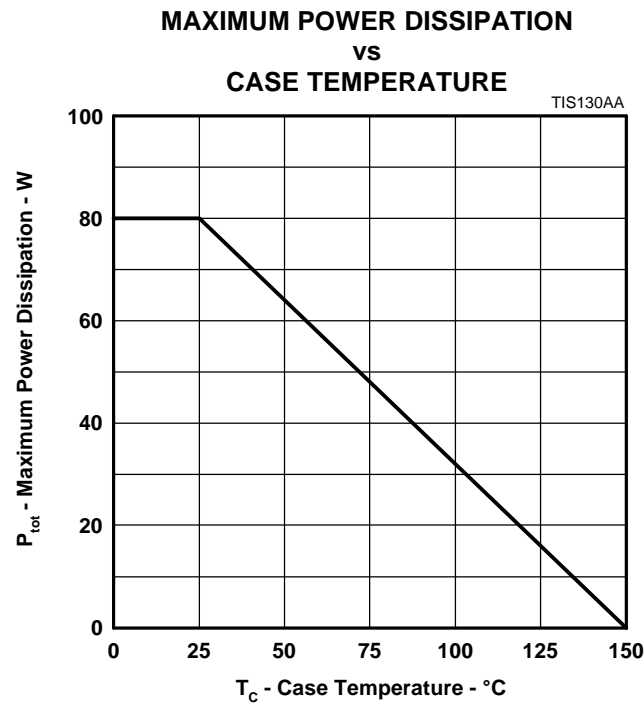


Figure 4.

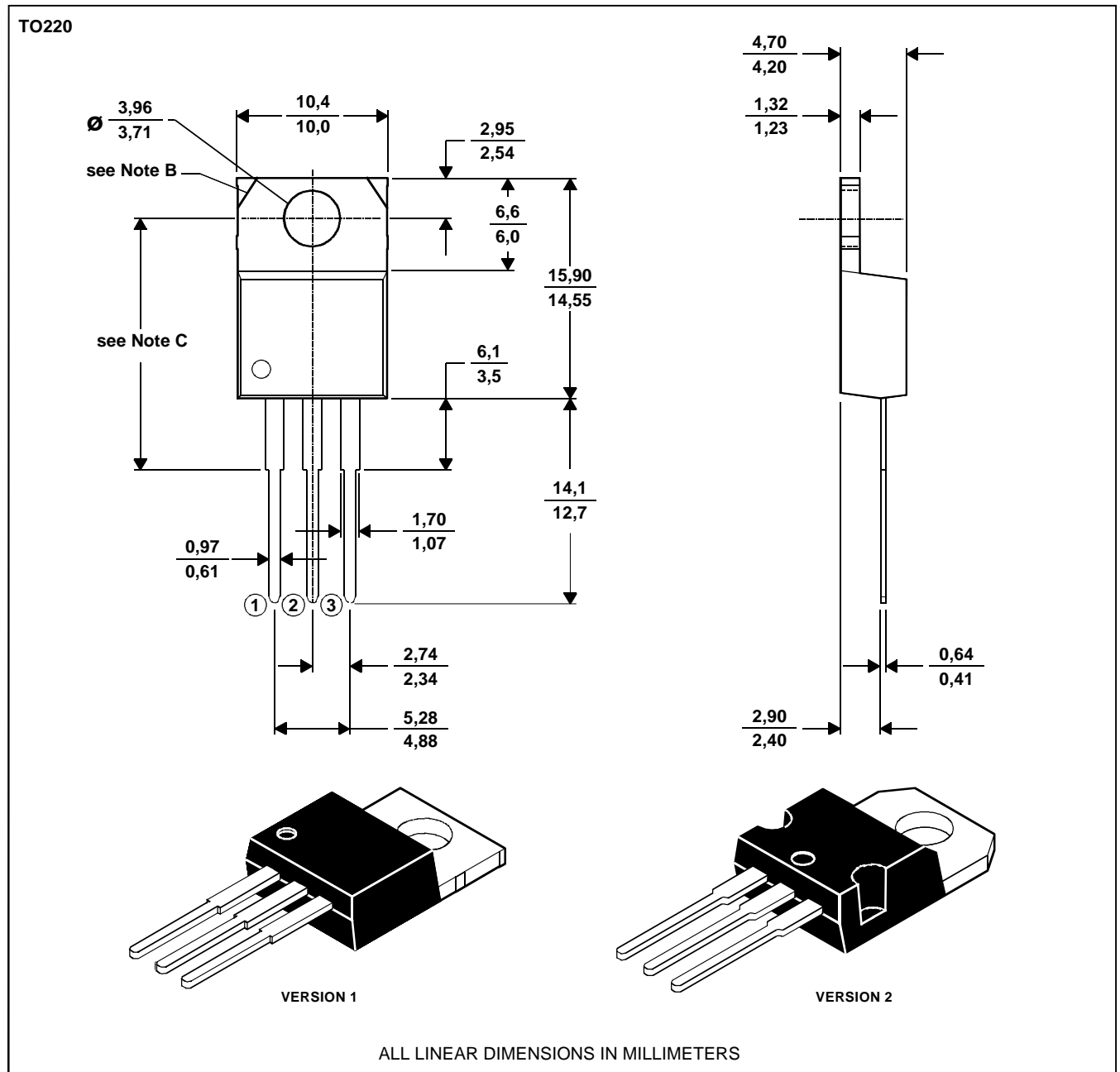
PRODUCT INFORMATION

## MECHANICAL DATA

### TO-220

#### 3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



- NOTES: A. The centre pin is in electrical contact with the mounting tab.  
B. Mounting tab corner profile according to package version.  
C. Typical fixing hole centre stand off height according to package version.  
Version 1, 18.0 mm. Version 2, 17.6 mm.

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# **BDW94, BDW94A, BDW94B, BDW94C PNP SILICON POWER DARLINGTONS**

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